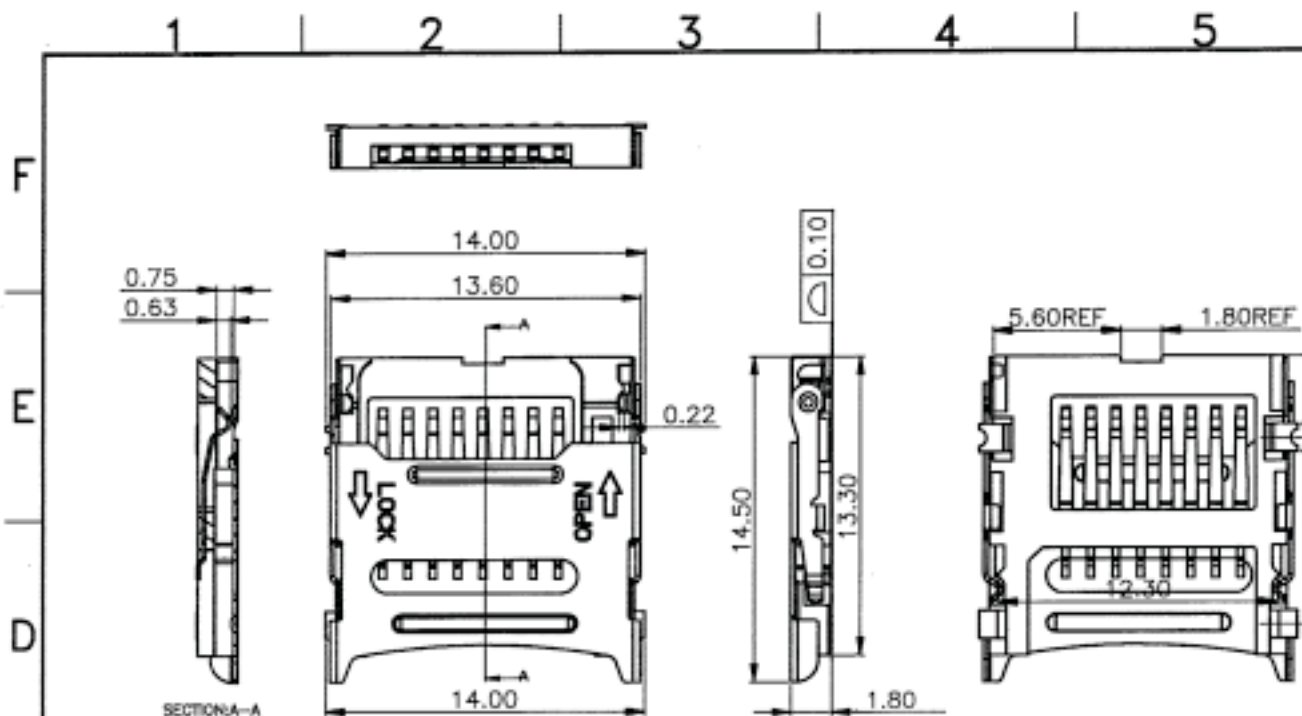


REV	MODIFICATION	DATE	DRAW
F	EN-10-0212	99.02.09	SAN
G	EN-10-0924	99.09.27	SAN
H	EN-11-0716	100.07.18	Stacy



MATERIALS

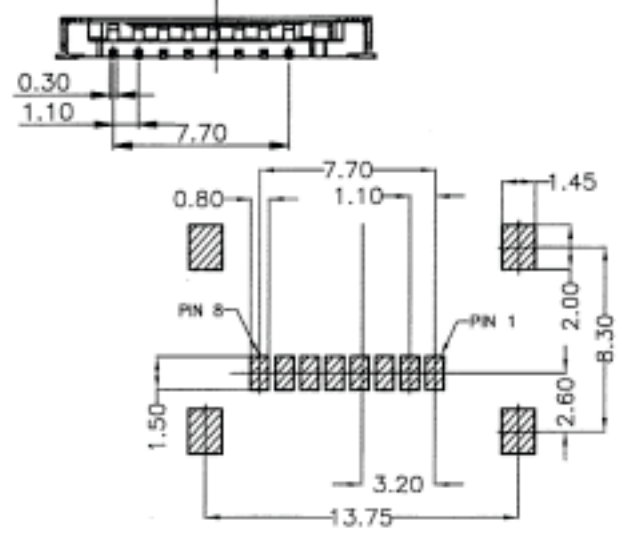
HOUSING: HI-TEMP. PLASTIC (UL 94V-0)
 SHELL: STAINLESS STEEL
 SOLDER PAD: COPPER ALLOY, TIN PLATING
 TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA
 TIN PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 0.5 AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 100m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -20°C~+60°C

ORDER INFORMATION:

TFDMF-108 XX B I 00
 PLATING ——— COMPLY TO RoHS
 01:GOLD FLASH
 05:5u" GOLD



P.C.B LAYOUT
 TOP VIEW ±0.05



F
E
D
C
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A

F
E
D
C
B
A

1 2 3 4 5 6 7 8